PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yoshinori Hayashi	07/08/2009
Hideki Mori	07/08/2009

RECEIVING PARTY DATA

Name:	SHIBAURA MECHATRONICS CORPORATION	
Street Address:	2-5-1, Kasama, Sakae-ku,	
City:	Yokohama-shi, Kanagawa	
State/Country:	JAPAN	
Postal Code:	247-8610	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12531429

CORRESPONDENCE DATA

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NAME OF SUBMITTER:

Mel R. Quintos

Total Attachments: 1

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PATENT REEL: 023272 FRAME: 0025 ICH \$40.00 12

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U.S. ASSIGNMENT

(Insert ASSIGNEE's Name(s) Address(es))

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by SHIBAURA MECHATRONICS CORPORATION

2-5-1, Kasama, Sakae-ku, Yokohama-shi, Kanagawa 247-8610 Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled:

(Title of Invention)

APPARATUS AND METHOD FOR INSPECTING EDGE OF SEMICONDUCTOR WAFER

(*If the assignment is being filed after the filing of the application, this section must be completed) for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

September 15, 2009

* filed on _____, Serial No. 12/531,429

(Kratz, Quintos & Hanson, LLP is hereby authorized to insert the serial code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

Yoshinori Hayashi (Type Name) Hideki Mori (Type Name) (Date) (Signature) (Type Name) (Date) (Type Name) (Signature) (Date) (Signature) (Type Name) (Type Name) (Date) (Signature)

NO LEGALIZATION REQUIRED

Re. 07/07

PATENT
RECORDED: 09/23/2009 REEL: 023272 FRAME: 0026